

TOSHIBA LED LAMP InGaAlP YELLOW LIGHT EMISSION

TLYH180P

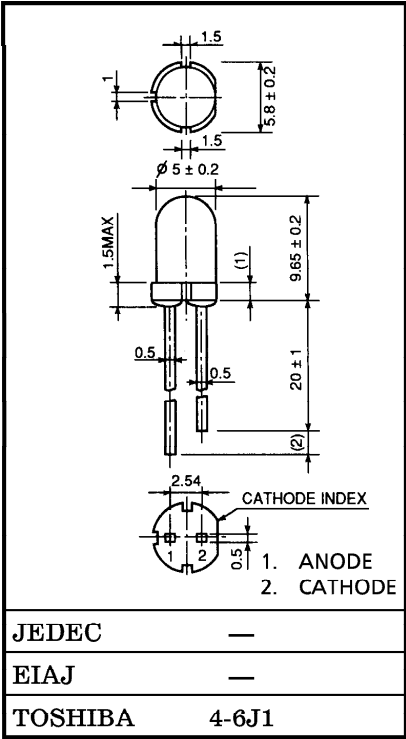
PANEL CIRCUIT INDICATOR

- 5mm DIAMETER (T1-3 / 4)
- InGaAlP YELLOW LED
- All Plastic Mold Type.
- Colorless Clear Lens
- Low Drive Current, High Intensity Yellow Light Emission  
Recommended Forward Current :  $I_F=1\sim20\text{mA}$  (DC)
- All Plastic Molded Lens, Provides an Excellent ON-OFF Contrast Ratio.
- Fast Response Time, Capable of Pulse Operation.
- High Power Luminous Intensity
- Without stand-offs
- APPLICATIONS : Suitable for Outdoor Message Signboard, Safety equipment.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Forward Current (DC)	$I_F$	50	mA
Reverse Voltage	$V_R$	4	V
Power Dissipation	$P_D$	125	mW
Operating Temperature Range	$T_{opr}$	-30~85	°C
Storage Temperature Range	$T_{stg}$	-40~120	°C

Unit in mm



Weight : 0.31g

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## ELECTRO-OPTICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Forward Voltage		$V_F$	$I_F = 20\text{mA}$	—	2.1	2.5	V
Reverse Current		$I_R$	$V_R = 4\text{V}$	—	—	50	$\mu\text{A}$
Luminous Intensity	TLYH180P	$I_V$	$I_F = 20\text{mA}$ (Note)	2720	8000	—	mcd
	TLYH180P (UV)			2720	—	12900	
Peak Emission Wavelength		$\lambda_p$	$I_F = 20\text{mA}$	—	590	—	nm
Spectral Line Half Width		$\Delta\lambda$	$I_F = 20\text{mA}$	—	13	—	nm
Dominant Wavelength		$\lambda_d$	$I_F = 20\text{mA}$	—	587	—	nm

(Note) Rank selection carried out under next range respectively, although it needs  $\pm 15\%$  additional for guaranteed limits.

U : 3200-6400mcd, V : 5600-11200mcd, W : 10000-20000mcd.

## PRECAUTION

Please be careful of the followings

- Soldering temperature : 260°C MAX. Soldering time : 3s MAX.  
(Soldering portion of lead : up to 2mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.

